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Title of Invention:

SEMICONDUCTOR PACKAGE AND
METHOD OF MAKING
LEADFRAME HAVING LEAD
LOCKS TO SECURE LEADS TO
ENCAPSULANT

First Named Inventor: Jae Yee

Domestic/Foreign Application: Domestic Application

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Statement

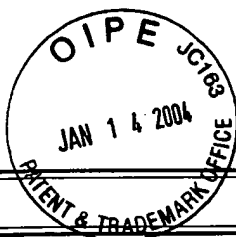
Filing Type:

Confirmation number: 7012

Attorney Docket Number: AMKOR012G1

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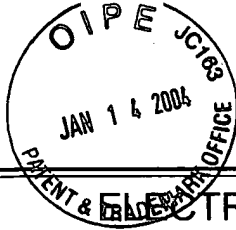


TRANSMITTAL

Electronic Version v1.1


Stylesheet Version v1.1.0

| Title of Invention | SEMICONDUCTOR PACKAGE AND METHOD OF MAKING LEADFRAME HAVING LEAD LOCKS TO SECURE LEADS TO ENCAPSULANT | | | | | | | | | |
|--|---|----------------|---------------------------|-------------|----------------|---|-------|------------|--|------------|
| Application Number: 10/667227  | | | | | | | | | | |
| Date: 2003-09-18 | | | | | | | | | | |
| First Named Applicant: Jae Hak Yee | | | | | | | | | | |
| Confirmation Number: 7012 | | | | | | | | | | |
| Attorney Docket Number: AMKOR012G1 | | | | | | | | | | |
| <p>I hereby certify that the use of this system is for OFFICIAL correspondence between patent applicants or their representatives and the USPTO. Fraudulent or other use besides the filing of official correspondence by authorized parties is strictly prohibited, and subject to a fine and/or imprisonment under applicable law.</p> <p>I, the undersigned, certify that I have viewed a display of document(s) being electronically submitted to the United States Patent and Trademark Office, using either the USPTO provided style sheet or software, and that this is the document(s) I intend for initiation or further prosecution of a patent application noted in the submission. This document(s) will become part of the official electronic record at the USPTO.</p> | | | | | | | | | | |
| <table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Mark B. Garred Registered Number: 34,823</td><td>/mbg/</td><td>Attorney</td></tr></tbody></table> | | | Submitted by: | Elec. Sign. | Sign. Capacity | Mark B. Garred Registered Number: 34,823 | /mbg/ | Attorney | | |
| Submitted by: | Elec. Sign. | Sign. Capacity | | | | | | | | |
| Mark B. Garred Registered Number: 34,823 | /mbg/ | Attorney | | | | | | | | |
| <table><tr><td>Documents being submitted</td><td>Files</td></tr><tr><td>us-ids</td><td>ids3-usidst.xml</td></tr><tr><td></td><td>us-ids.dtd</td></tr><tr><td></td><td>us-ids.xsl</td></tr></table> | | | Documents being submitted | Files | us-ids | ids3-usidst.xml | | us-ids.dtd | | us-ids.xsl |
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| | us-ids.xsl | | | | | | | | | |
| Comments | | | | | | | | | | |



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18
Stylesheet Version v18.0

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|---|---|--|------------|------------------|---|-------|----------|
| Title of Invention | SEMICONDUCTOR PACKAGE AND METHOD OF MAKING LEADFRAME HAVING LEAD LOCKS TO SECURE LEADS TO ENCAPSULANT | | | | | | |
| Application Number: | | 10/667227 | | |  | | |
| Confirmation Number: | | 7012 | | | | | |
| First Named Applicant: | | Jae Yee | | | | | |
| Attorney Docket Number: | | AMKOR012G1 | | | | | |
| Art Unit: | | 2812 | | | | | |
| Search string: | | (5640047 or 5639990 or 5641997 or 5644169 or 5643433 or 5646831 or 5650663 or 5661088 or 5665996 or 5673479 or 5683806 or 5689135 or 5696666 or 5701034 or 5703407 or 5710064 or 5724233 or 5723899 or 5736432 or 5745984 or 5753977 or 5753532 or 5766972 or 5770888 or 5776798 or 5783861 or 5801440 or 5814884 or 5814883 or 5814881 or 5814877 or 5818105 or 5817540 or 5821615 or 5821457 or 5835988 or 5834830 or 5844306 or 5856911 or 5859471 or 5866939 or 5871782 or 5874784 or 5877043 or 5886398 or 5886397 or 5894108 or 5897339 or 5900676 or 5903050).pn. | | | | | |
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| Note: Applicant is not required to submit a paper copy of cited US Patent Documents | | | | | | | |
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Signature

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| Examiner Name | Date |
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